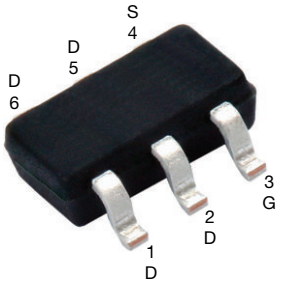
P-Channel 80 V (D-S) MOSFET

TSOP-6 Single



Top View

Marking Code: BU

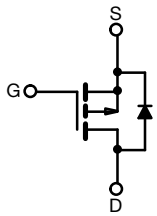
FEATURES

- TrenchFET® power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free
RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- Power management for portable and consumer
  - Load switches
  - DC/DC converters



P-Channel MOSFET

PRODUCT SUMMARY	
V_{DS} (V)	-80
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0827
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.1242
Q_g typ. (nC)	5.6
I_D (A) [a]	-5.4
Configuration	Single

ORDERING INFORMATION	
Package	TSOP-6 Single
Lead (Pb)-free and halogen-free	Si3129DV-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	-80	V
Gate-source voltage		V_{GS}	±20	
Continuous drain current (T_J = 150 °C)	T_C = 25 °C	I_D	-5.4	A
	T_C = 70 °C		-4.4	
	T_A = 25 °C		-3.8 [b, c]	
	T_A = 70 °C		-3.0 [b, c]	
Pulsed drain current (t = 300 µs)		I_{DM}	-20	
Continuous source-drain diode current	T_C = 25 °C	I_S	-3.5	
	T_A = 25 °C		-1.7 [b, c]	
Single pulse avalanche energy	L = 0.1 mH	I_{AS}	15	
		E_{AS}	11	
Maximum power dissipation	T_C = 25 °C	P_D	4.2	W
	T_C = 70 °C		2.7	
	T_A = 25 °C		2 [b, c]	
	T_A = 70 °C		1.3 [b, c]	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient [b, d]	t ≤ 5 s	R_{thJA}	45	62.5	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	25	30	

Notes

a. T_C = 25 °C
b. Surface mounted on 1" x 1" FR4 board
c. t = 5 s
d. Maximum under steady state conditions is 110 °C/W

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = -250 μA	-80	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	I_D = -10 mA	-	-115	-	mV/°C
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$	I_D = 250 μA	-	4.8	-	
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250 μA	-1.5	-	-2.5	V
Gate-source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	V_{DS} = -80 V, V_{GS} = 0 V	-	-	-10	μA
		V_{DS} = -80 V, V_{GS} = 0 V, T_J = 55 °C	-	-	-50	
On-state drain current [a]	$I_{D(on)}$	$V_{DS} \leq$ -5 V, V_{GS} = -10 V	-5	-	-	A
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} = -10 V, I_D = -3.8 A	-	0.0689	0.0827	Ω
		V_{GS} = -4.5 V, I_D = -3.1 A	-	0.0994	0.1242	
Dynamic [b]						
Input capacitance	C_{iss}	V_{DS} = -40 V, V_{GS} = 0 V, f = 1 MHz	-	805	-	pF
Output capacitance	C_{oss}		-	265	-	
Reverse transfer capacitance	C_{rss}		-	10	-	
Total gate charge	Q_g	V_{DS} = -40 V, V_{GS} = -10 V, I_D = -3.8 A	-	12	18	nC
		V_{DS} = -40 V, V_{GS} = -4.5 V, I_D = -3.8 A	-	5.6	8.4	
Gate-source charge	Q_{gs}		-	3.1	-	
Gate-drain charge	Q_{gd}		-	1.4	-	
Gate resistance	R_g	f = 1 MHz	0.8	4.4	8.8	Ω
Turn-on delay time	$t_{d(on)}$	V_{DD} = -40 V, R_L = 13.3 Ω $I_D \cong$ -3 A, V_{GEN} = - 10 V, R_g = 1 Ω	-	15	30	ns
Rise time	t_r		-	8	16	
Turn-off delay time	$t_{d(off)}$		-	25	50	
Fall time	t_f		-	12	24	
Turn-on delay time	$t_{d(on)}$	V_{DD} = -40 V, R_L = 13.3 Ω $I_D \cong$ -3 A, V_{GEN} = - 4.5, R_g = 1 Ω	-	28	56	
Rise time	t_r		-	42	84	
Turn-off delay time	$t_{d(off)}$		-	24	48	
Fall time	t_f		-	15	30	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I_S	T_C = 25 °C	-	-	-3.5	A
Pulse diode forward current	I_{SM}		-	-	-20	
Body diode voltage	V_{SD}	I_S = -3 A, V_{GS} = 0 V	-	-0.8	-1.2	V
Body diode reverse recovery time	t_{rr}	I_F = -3 A, dI/dt = 100 A/μs, T_J = 25 °C	-	38	57	ns
Body diode reverse recovery charge	Q_{rr}		-	50	75	nC
Reverse recovery fall time	t_a		-	26	-	ns
Reverse recovery rise time	t_b		-	12	-	

Notes

a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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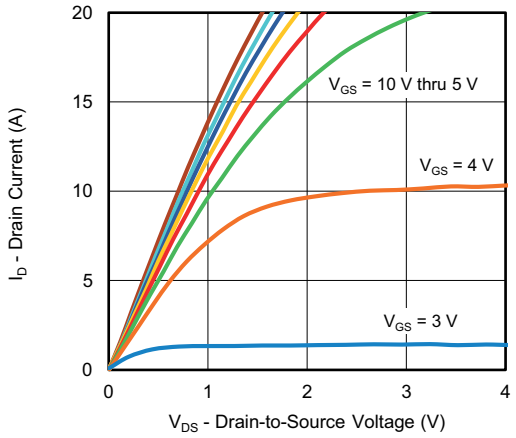
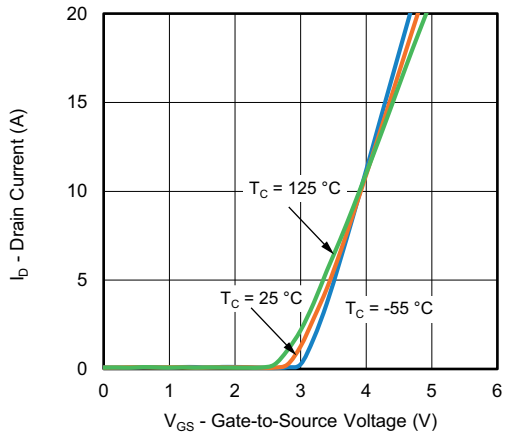
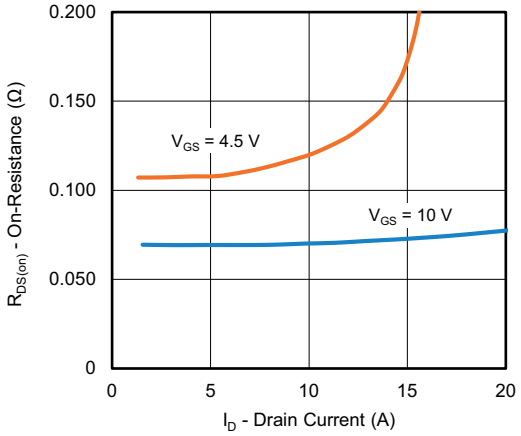


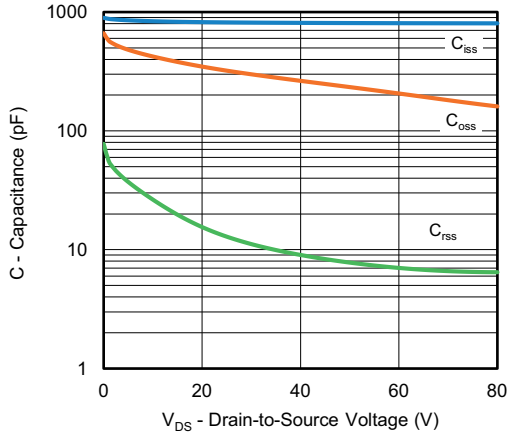
Output Characteristics



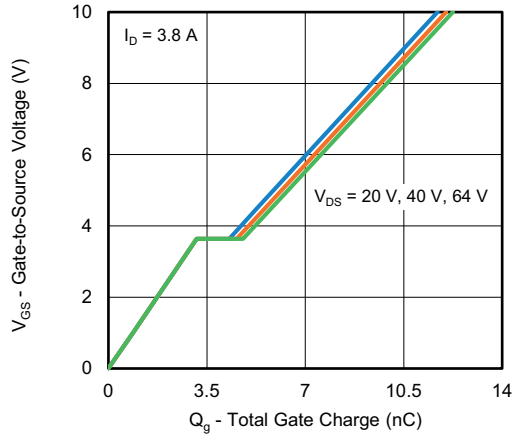
Transfer Characteristics



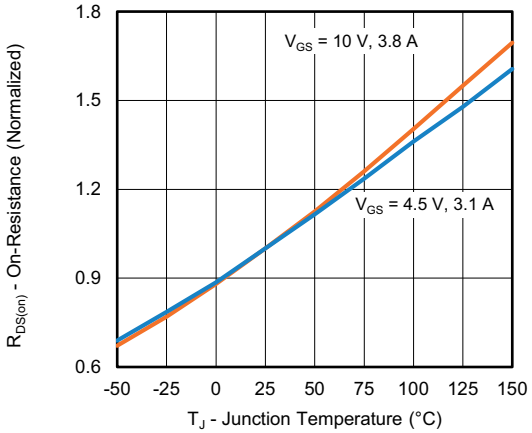
On-Resistance vs. Drain Current



Capacitance



Gate Charge



On-Resistance vs. Junction Temperature

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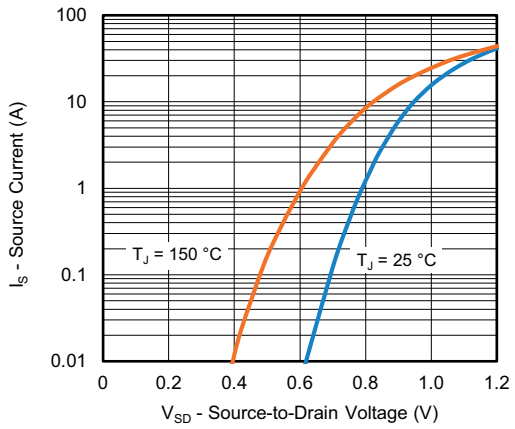
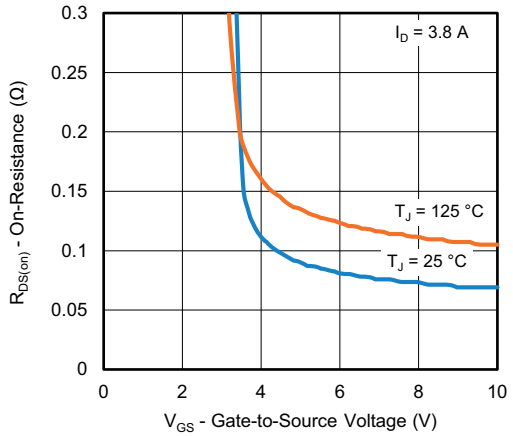
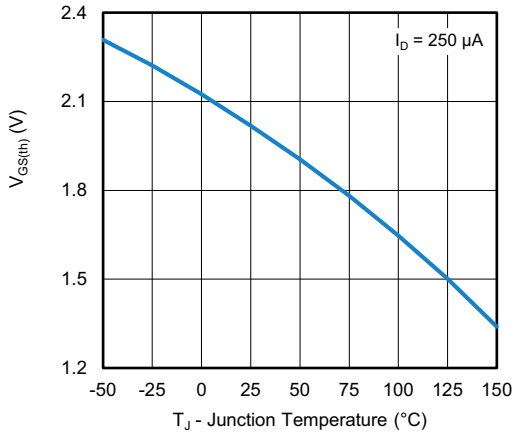


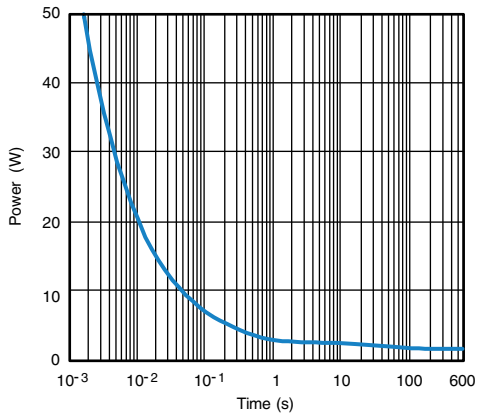
Source-Drain Diode Forward Voltage



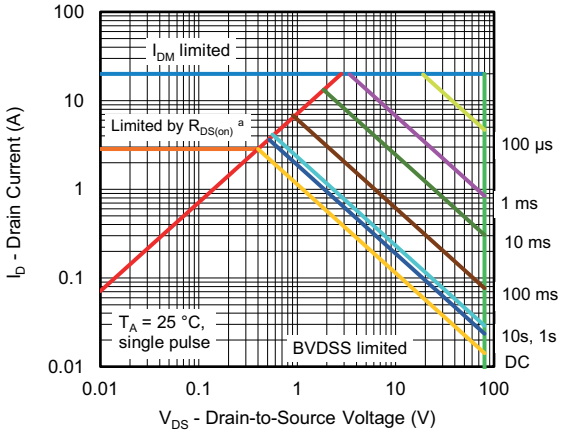
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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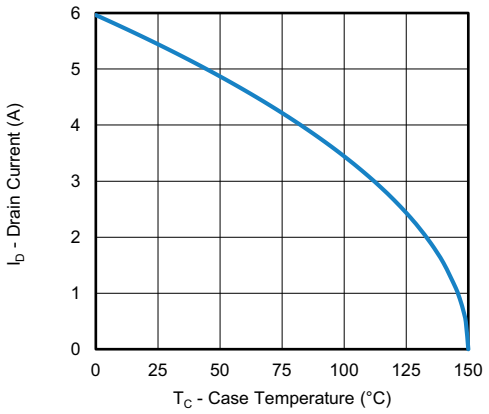
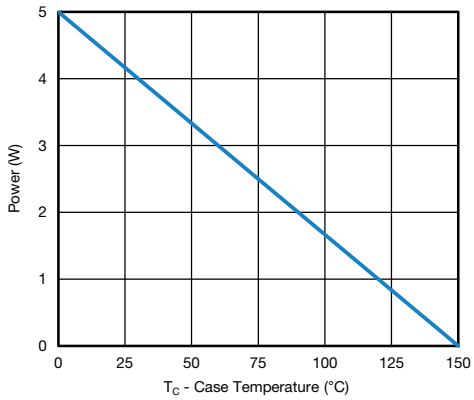


Current Derating [a]



Power Junction-to-Case

Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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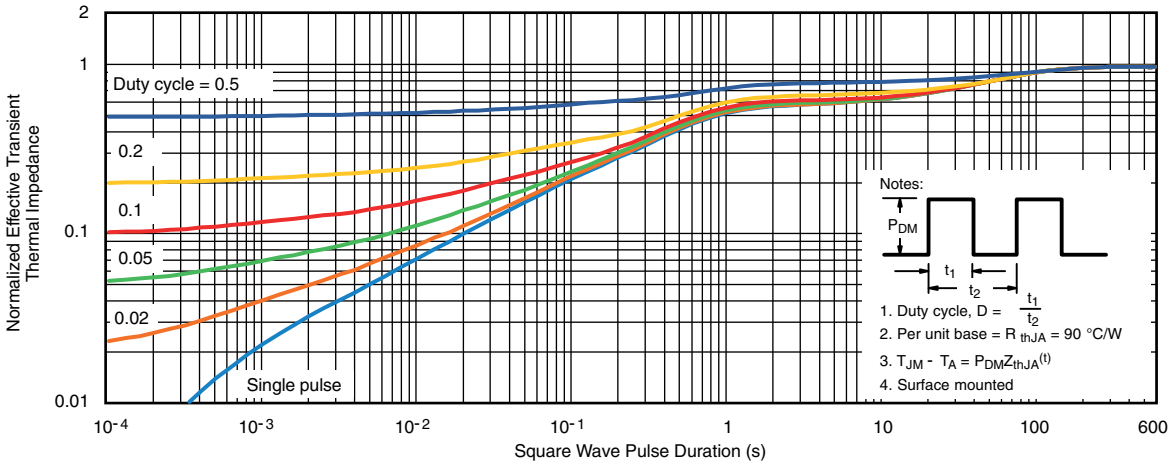
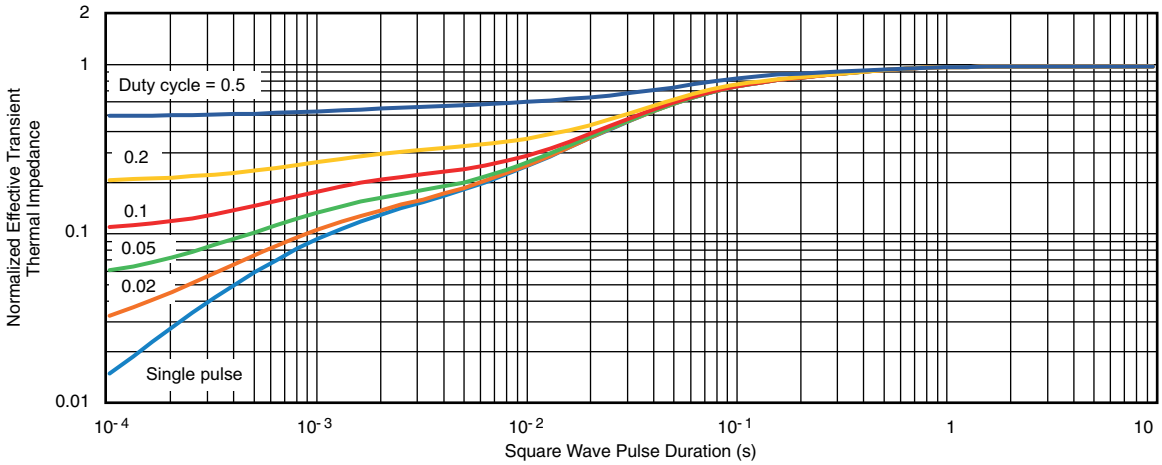


Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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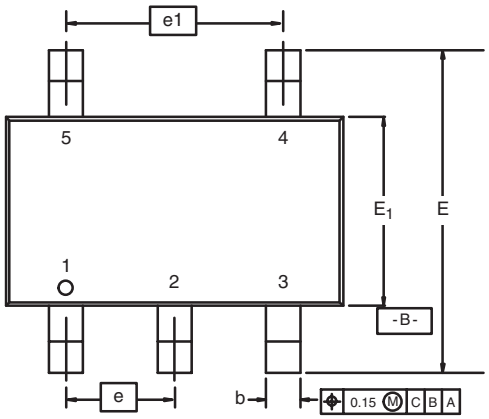
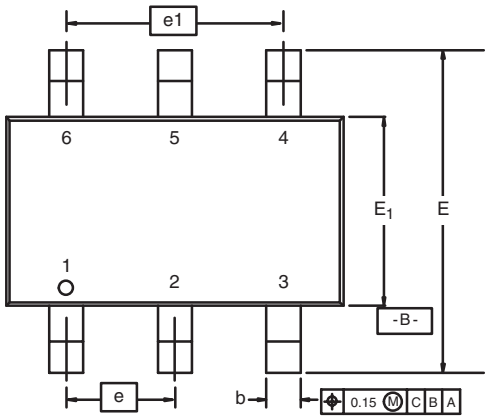
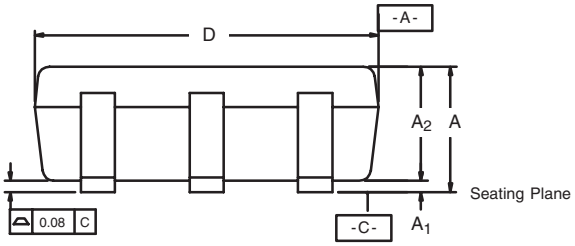
TSOP: 5/6–LEAD
JEDEC Part Number: MO-193C

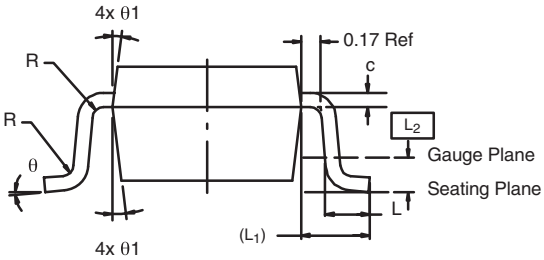


5-LEAD TSOP



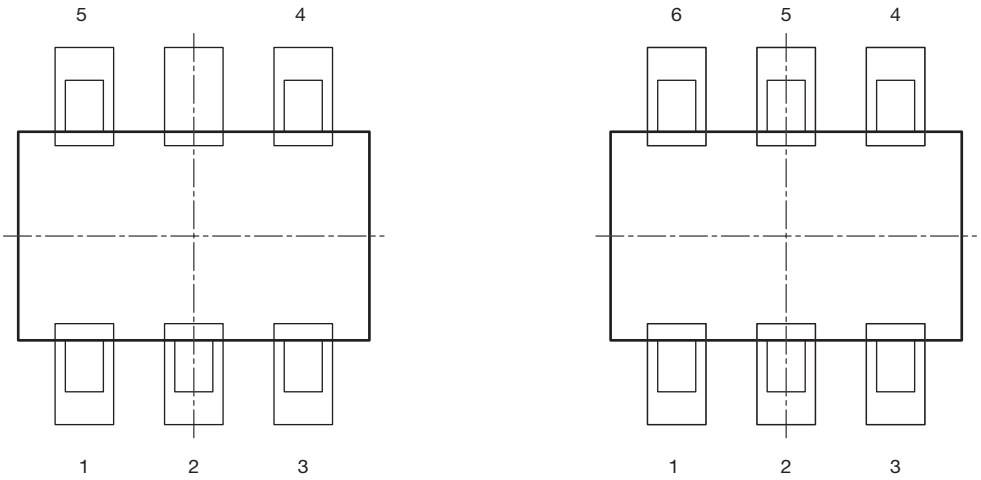
6-LEAD TSOP





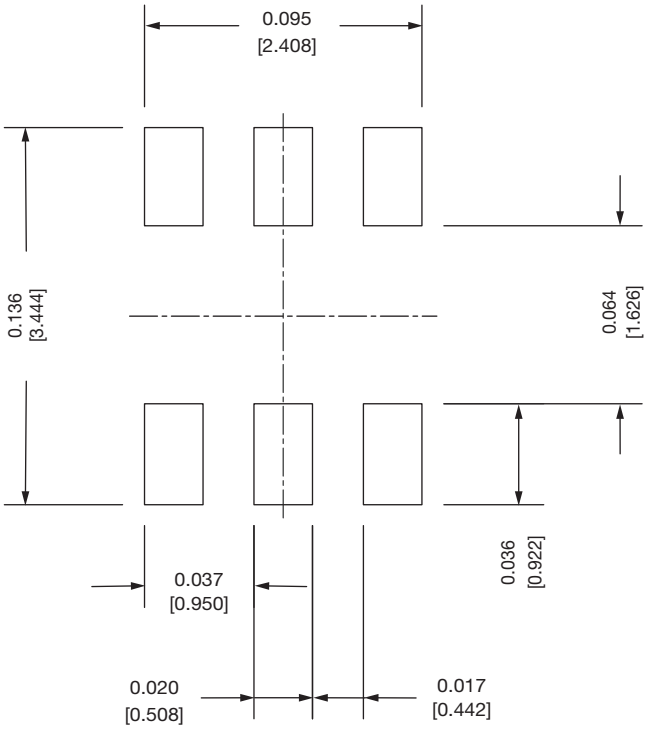
Dim	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
A	0.91	-	1.10	0.036	-	0.043
A_1	0.01	-	0.10	0.0004	-	0.004
A_2	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.106	0.112	0.117
E_1	1.55	1.65	1.70	0.061	0.065	0.067
e	0.95 BSC			0.0374 BSC		
e_1	1.80	1.90	2.00	0.071	0.075	0.079
L	0.32	-	0.50	0.012	-	0.020
L_1	0.60 Ref			0.024 Ref		
L_2	0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-
θ	0°	4°	8°	0°	4°	8°
θ_1	7° Nom			7° Nom		
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540						

Recommended Land Pattern For TSOP-5L / TSOP-6L



TSOP 5L

TSOP 6L



Note

- All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022
DWG: 3010

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